

TAIWAN SEMICONDUCTOR MANUFACTURING CO LTD

Form 6-K

November 10, 2009

1934 Act Registration No. 1-14700  
**SECURITIES AND EXCHANGE COMMISSION**  
**Washington, DC 20549**

**FORM 6-K**

**REPORT OF FOREIGN PRIVATE ISSUER  
PURSUANT TO RULE 13a-16 OR 15d-16 OF  
THE SECURITIES EXCHANGE ACT OF 1934**

For the month of November 2009

**Taiwan Semiconductor Manufacturing Company Ltd.**

(Translation of Registrant's Name Into English)

**No. 8, Li-Hsin Rd. 6,  
Hsinchu Science Park,  
Taiwan**

(Address of Principal Executive Offices)

(Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.)

Form 20-F  Form 40-F

(Indicate by check mark whether the registrant by furnishing the information contained in this form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934.)

Yes  No

(If "Yes" is marked, indicated below the file number assigned to the registrant in connection with Rule 12g3-2(b):  
82: \_\_\_\_\_.)

---

**TSMC Board of Directors Resolutions**

**Hsinchu, Taiwan, R.O.C., November 10, 2009** TSMC (NYSE: TSM) today held a meeting of the Board of Directors, which passed the following resolutions:

1. Approved capital appropriations of US\$2,240.8 million to expand advanced technology capacity for twelve-inch wafer fabs, and increase twelve-inch capacity for wafer level chip scale packaging process.
2. Approved capital appropriations of US\$254.6 million to expand 12-inch wafer fab facilities.
3. Approved capital appropriations of US\$46 million to set up a production line and product development lab for solid state lighting.
4. Appointed Dr. Jack Sun as Chief Technology Officer of TSMC, in charge of formulating TSMC's technology strategy and conducting the development of the company's most advanced technologies. Dr. Sun will report directly to Dr. S.Y. Chiang, Senior Vice President of Research and Development.

###

**TSMC Spokesperson**

Ms. Lora Ho  
Vice President and  
CFO  
Tel: 886-3-566-4602

**TSMC Acting Spokesperson:**

Mr. J.H. Tzeng  
Deputy Director  
PR Department  
Tel: 886-3-505-5028  
Mobile: 886-928-882-607  
E-Mail: jhtzeng@tsmc.com

**For Further Information:**

Michael Kramer  
Principal Specialist  
PR Department  
Tel: 886-3-563-6688  
ext.7126216  
Mobile: 886-926-026-632  
E-Mail:  
pdkramer@tsmc.com

Dana Tsai  
Senior Administrator, PR  
Department  
Tel: 886-3-505-5036  
Mobile: 886-920-483591  
E-Mail: dana\_tsai@tsmc.com

**SIGNATURES**

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

Taiwan Semiconductor Manufacturing  
Company Ltd.

Date: November 10, 2009

By /s/ Lora Ho  
Lora Ho  
Vice President & Chief Financial  
Officer